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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

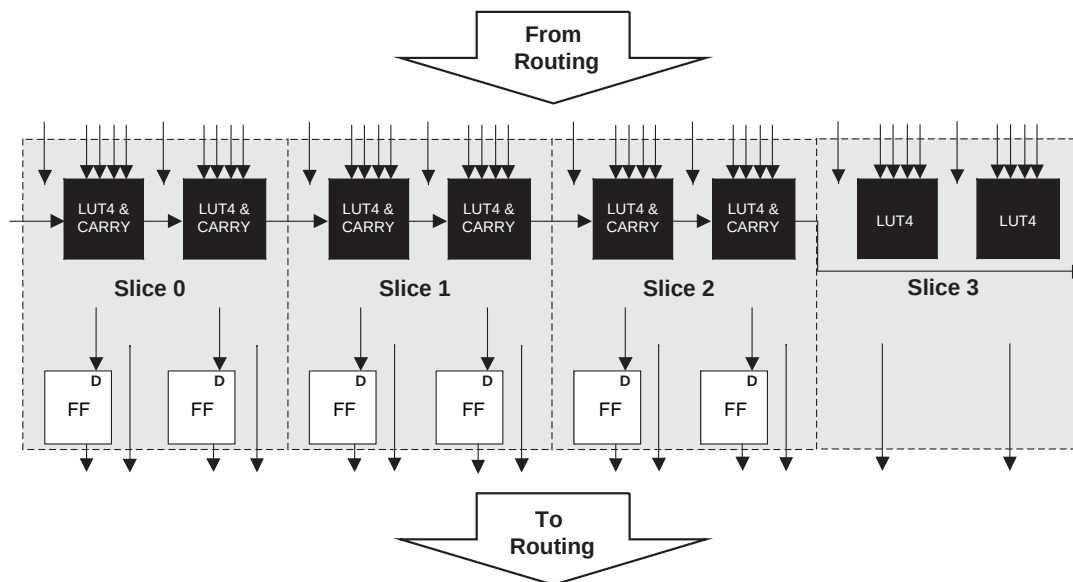
Product Status	Active
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	270
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50se-6fn484c

PFU Blocks

The core of the LatticeECP2/M device consists of PFU blocks, which are provided in two forms, the PFU and PFF. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of this data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 50 inputs and 23 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

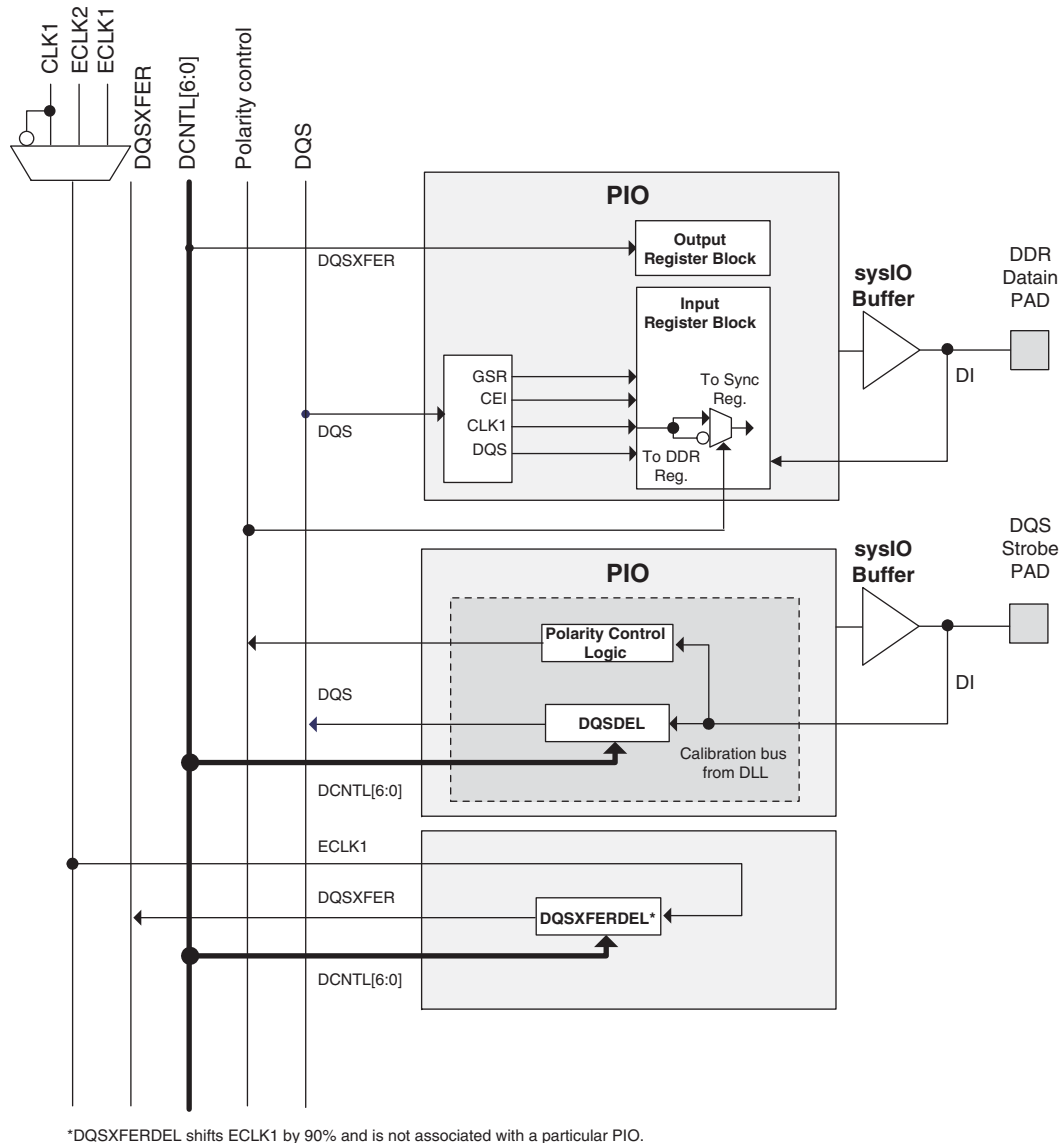
Slice 0 through Slice 2 contain two LUT4s feeding two registers, whereas Slice 3 contains two LUT4s only. For PFUs, Slice 0 and Slice 2 can also be configured as distributed memory, a capability not available in the PFF. Table 2-1 shows the capability of the slices in both PFF and PFU blocks along with the operation modes they enable. In addition, each PFU contains some logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge triggered or level sensitive clocks.

Table 2-1. Resources and Modes Available per Slice

Slice	PFU BLock		PFF Block	
	Resources	Modes	Resources	Modes
Slice 0	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 1	2 LUT4s and 2 Registers	Logic, Ripple, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 2	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 3	2 LUT4s	Logic, ROM	2 LUT4s	Logic, ROM

Slices 0, 1 and 2 have 14 input signals: 13 signals from routing and one from the carry-chain (from the adjacent slice or PFU). There are seven outputs: six to routing and one to carry-chain (to the adjacent PFU). Slice 3 has 13 input signals from routing and four signals to routing. Table 2-2 lists the signals associated with Slice 0 to Slice 2.

Figure 2-36. DQS Local Bus



*DQSXFERDEL shifts ECLK1 by 90° and is not associated with a particular PIO.

Polarity Control Logic

In a typical DDR Memory interface design, the phase relationship between the incoming delayed DQS strobe and the internal system clock (during the READ cycle) is unknown.

The LatticeECP2/M family contains dedicated circuits to transfer data between these domains. To prevent set-up and hold violations, at the domain transfer between DQS (delayed) and the system clock, a clock polarity selector is used. This changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each READ cycle for the correct clock polarity.

Prior to the READ operation in DDR memories, DQS is in tristate (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit detects the first DQS rising edge after the preamble state. This signal is used to control the polarity of the clock to the synchronizing registers.

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter	Description	Test Conditions	Min.	Typ.	Max.	Units
$V_{INP} V_{INM}$	Input Voltage		0	—	2.4	V
V_{CM}	Input Common Mode Voltage	Half the Sum of the Two Inputs	0.05	—	2.35	V
V_{THD}	Differential Input Threshold	Difference Between the Two Inputs	+/-100	—	—	mV
I_{IN}	Input Current	Power On or Power Off	—	—	+/-10	μ A
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	—	1.38	1.60	V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	0.9V	1.03	—	V
V_{OD}	Output Voltage Differential	$(V_{OP} - V_{OM})$, $R_T = 100 \text{ Ohm}$	250	350	450	mV
ΔV_{OD}	Change in V_{OD} Between High and Low		—	—	50	mV
V_{OS}	Output Voltage Offset	$(V_{OP} + V_{OM})/2$, $R_T = 100 \text{ Ohm}$	1.125	1.20	1.375	V
ΔV_{OS}	Change in V_{OS} Between H and L		—	—	50	mV
I_{SA}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Ground	—	—	24	mA
I_{SAB}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Each Other	—	—	12	mA

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{H_DELE}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f _{MAX_IOE}	Clock Frequency of I/O and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Primary Clock with PLL)¹									
t _{COPLL} ¹⁰	Clock to Output - PIO Output Register	LFE2-6	—	2.30	—	2.60	—	2.80	ns
		LFE2-12	—	2.30	—	2.60	—	2.80	ns
		LFE2-20	—	2.30	—	2.60	—	2.80	ns
		LFE2-35	—	2.30	—	2.60	—	2.80	ns
		LFE2-50	—	2.30	—	2.60	—	2.80	ns
		LFE2-70	—	2.30	—	2.60	—	2.80	ns
		LFE2M20	—	2.30	—	2.60	—	2.80	ns
		LFE2M35	—	2.30	—	2.60	—	2.80	ns
		LFE2M50	—	2.60	—	2.90	—	3.10	ns
		LFE2M70	—	2.60	—	2.90	—	3.10	ns
		LFE2M100	—	2.70	—	3.00	—	3.20	ns
t _{SUPLL}	Clock to Data Setup - PIO Input Register	LFE2-6	0.70	—	0.80	—	0.90	—	ns
		LFE2-12	0.70	—	0.80	—	0.90	—	ns
		LFE2-20	0.70	—	0.80	—	0.90	—	ns
		LFE2-35	0.70	—	0.80	—	0.90	—	ns
		LFE2-50	0.70	—	0.80	—	0.90	—	ns
		LFE2-70	0.70	—	0.80	—	0.90	—	ns
		LFE2M20	0.70	—	0.80	—	0.90	—	ns
		LFE2M35	0.70	—	0.80	—	0.90	—	ns
		LFE2M50	0.70	—	0.80	—	0.90	—	ns
		LFE2M70	0.70	—	0.80	—	0.90	—	ns
		LFE2M100	0.80	—	0.90	—	1.00	—	ns

Figure 3-7. DDR and DDR2 Parameters

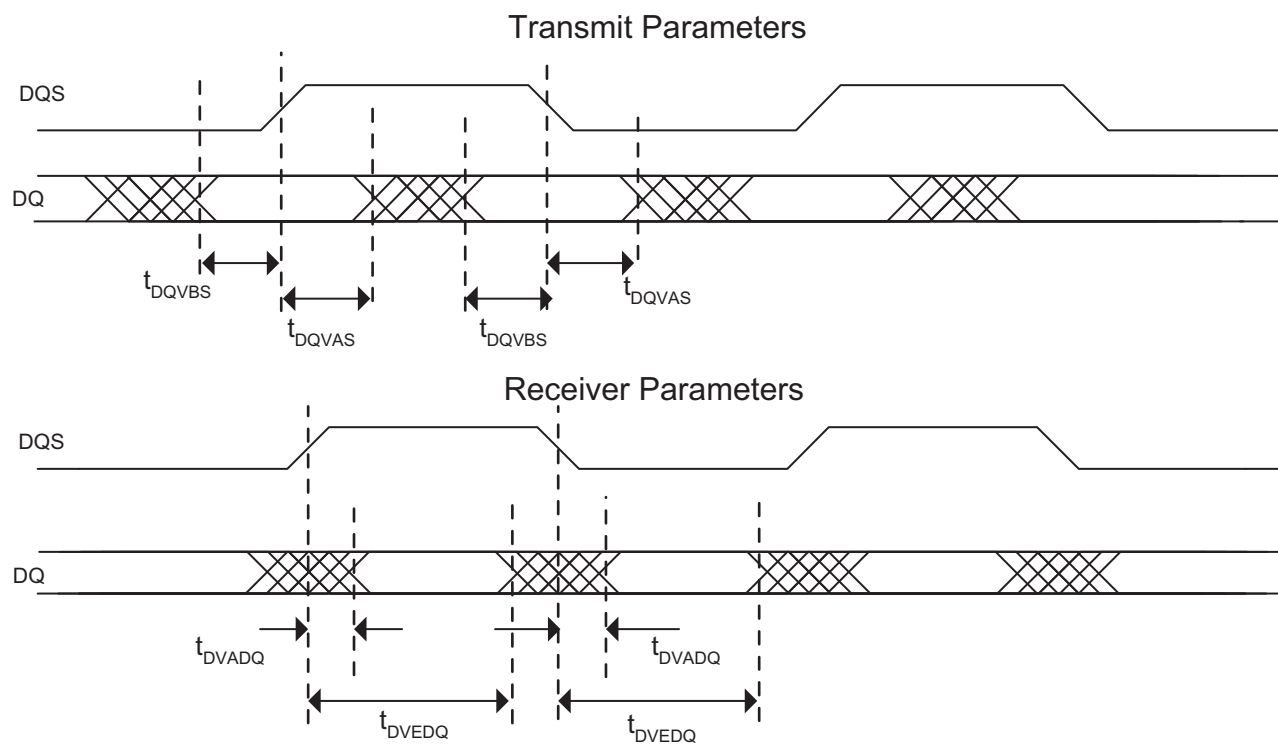


Figure 3-8. XGMII Parameters

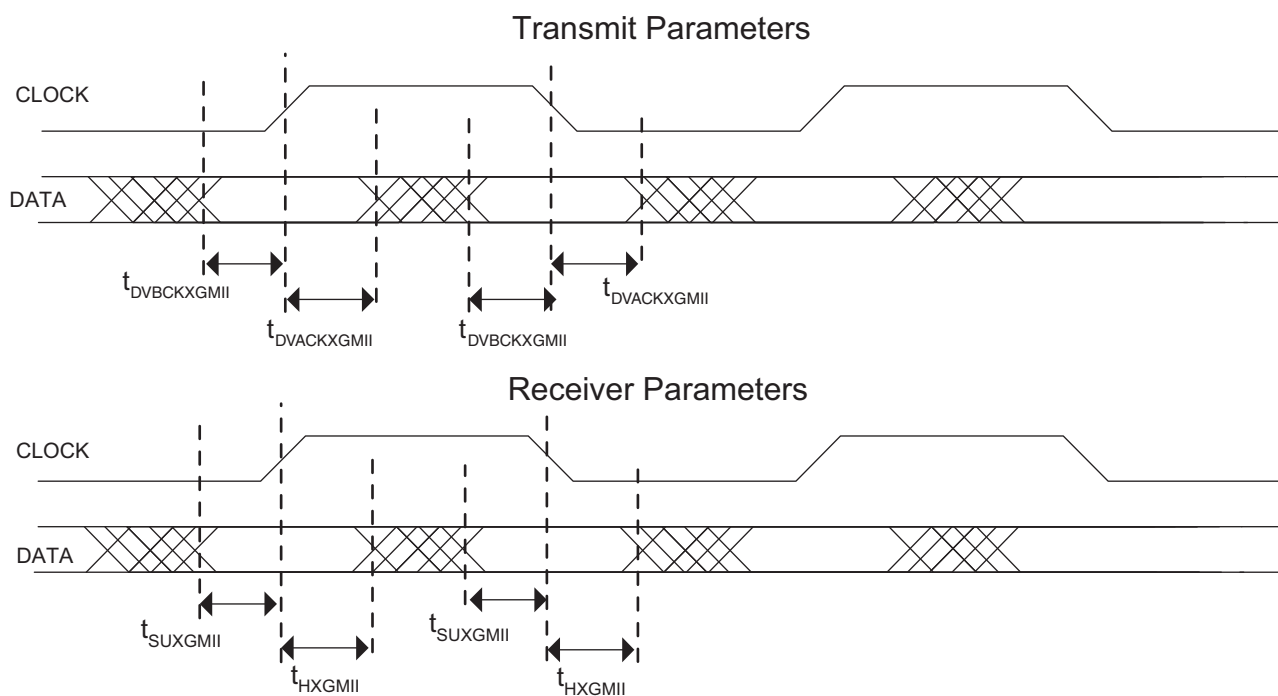
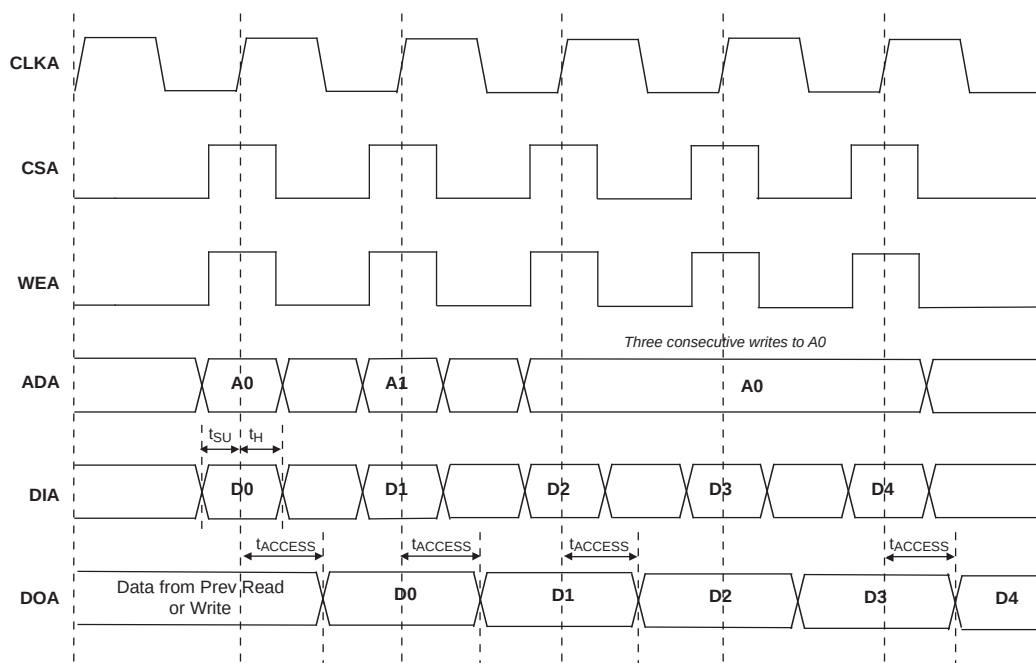


Figure 3-11. Write Through (SP Read/Write on Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)
Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
LVC MOS25_4mA	LVC MOS 2.5 4mA drive, slow slew rate	2.18	2.26	2.33	ns
LVC MOS25_8mA	LVC MOS 2.5 8mA drive, slow slew rate	2.19	2.35	2.51	ns
LVC MOS25_12mA	LVC MOS 2.5 12mA drive, slow slew rate	1.50	1.66	1.82	ns
LVC MOS25_16mA	LVC MOS 2.5 16mA drive, slow slew rate	1.60	1.59	1.58	ns
LVC MOS25_20mA	LVC MOS 2.5 20mA drive, slow slew rate	1.43	1.39	1.34	ns
LVC MOS18_4mA	LVC MOS 1.8 4mA drive, slow slew rate	2.22	2.27	2.32	ns
LVC MOS18_8mA	LVC MOS 1.8 8mA drive, slow slew rate	1.93	2.08	2.23	ns
LVC MOS18_12mA	LVC MOS 1.8 12mA drive, slow slew rate	1.43	1.51	1.58	ns
LVC MOS18_16mA	LVC MOS 1.8 16mA drive, slow slew rate	1.47	1.46	1.45	ns
LVC MOS15_4mA	LVC MOS 1.5 4mA drive, slow slew rate	2.32	2.38	2.43	ns
LVC MOS15_8mA	LVC MOS 1.5 8mA drive, slow slew rate	1.84	1.98	2.12	ns
LVC MOS12_2mA	LVC MOS 1.2 2mA drive, slow slew rate	2.52	2.63	2.74	ns
LVC MOS12_6mA	LVC MOS 1.2 6mA drive, slow slew rate	1.69	1.83	1.96	ns
PCI33	PCI33	0.04	0.04	0.04	ns

1. Timing Adders are characterized but not tested on every device.
 2. LVC MOS timing measured with the load specified in Switching Test Condition table.
 3. All other standards tested according to the appropriate specifications.
 4. These timing adders are measured with the recommended resistor values.
- Timing v.A 0.11

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA

LFE2-6E/SE					LFE2-12E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C3	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
C2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
-	-	-			-	-			
D3	PL5A	7		T	PL5A	7		T	
D4	PL4A	7		T (LVDS)*	PL4A	7		T (LVDS)*	
D2	PL5B	7		C	PL5B	7		C	
GND	GNDIO7	-			GNDIO7	-			
E4	PL4B	7		C (LVDS)*	PL4B	7		C (LVDS)*	
B1	PL7A	7	LDQ10	T	PL7A	7	LDQ10	T	
C1	PL7B	7	LDQ10	C	PL7B	7	LDQ10	C	
F5	PL9A	7	LDQ10	T	PL9A	7	LDQ10	T	
VCCIO	VCCIO7	7			VCCIO7	7			
F4	PL8A	7	LDQ10	T (LVDS)*	PL8A	7	LDQ10	T (LVDS)*	
G6	PL9B	7	LDQ10	C	PL9B	7	LDQ10	C	
G4	PL8B	7	LDQ10	C (LVDS)*	PL8B	7	LDQ10	C (LVDS)*	
D1	PL10A	7	LDQS10	T (LVDS)*	PL10A	7	LDQS10	T (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
E1	PL10B	7	LDQ10	C (LVDS)*	PL10B	7	LDQ10	C (LVDS)*	
F3	PL11A	7	LDQ10	T	PL11A	7	LDQ10	T	
G3	PL11B	7	LDQ10	C	PL11B	7	LDQ10	C	
VCCIO	VCCIO7	7			VCCIO7	7			
F2	PL12A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ10	T (LVDS)*	
F1	PL12B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ10	C (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
G2	PL13A	7	PCLKT7_0/LDQ10	T	PL13A	7	PCLKT7_0/LDQ10	T	
G1	PL13B	7	PCLKC7_0/LDQ10	C	PL13B	7	PCLKC7_0/LDQ10	C	
H6	PL15A	6	PCLKT6_0	T (LVDS)*	PL15A	6	PCLKT6_0	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
H5	PL15B	6	PCLKC6_0	C (LVDS)*	PL15B	6	PCLKC6_0	C (LVDS)*	
H4	PL16A	6	VREF2_6	T	PL16A	6	VREF2_6	T	
GND	GNDIO6	-			GNDIO6	-			
H3	PL16B	6	VREF1_6	C	PL16B	6	VREF1_6	C	
H2	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	
H1	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	
G10	VCC	-			VCC	-			
J4	PL18A	6	LLM0_GDLLT_FB_A	T	PL18A	6	LLM0_GDLLT_FB_A	T	
J5	PL18B	6	LLM0_GDLLC_FB_A	C	PL18B	6	LLM0_GDLLC_FB_A	C	
J6	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
K4	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	
GND	GNDIO6	-			GNDIO6	-			
J1	PL21A	6	LLM0_GPLLT_FB_A	T	PL21A	6	LLM0_GPLLT_FB_A	T	
K3	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
J2	PL21B	6	LLM0_GPLLC_FB_A	C	PL21B	6	LLM0_GPLLC_FB_A	C	

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
W5	PL38B	6	LDQ42	C (LVDS)*	PL52B	6	LDQ56	C (LVDS)*	
AC1	PL39A	6	LDQ42	T	PL53A	6	LDQ56	T	
AD1	PL39B	6	LDQ42	C	PL53B	6	LDQ56	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y6	PL40A	6	LDQ42	T (LVDS)*	PL54A	6	LDQ56	T (LVDS)*	
Y5	PL40B	6	LDQ42	C (LVDS)*	PL54B	6	LDQ56	C (LVDS)*	
AE2	PL41A	6	LDQ42	T	PL55A	6	LDQ56	T	
AD2	PL41B	6	LDQ42	C	PL55B	6	LDQ56	C	
GND	GNDIO6	-			GNDIO6	-			
AB3	PL42A	6	LDQS42	T (LVDS)*	PL56A	6	LDQS56	T (LVDS)*	
AB2	PL42B	6	LDQ42	C (LVDS)*	PL56B	6	LDQ56	C (LVDS)*	
W7	PL43A	6	LDQ42	T	PL57A	6	LDQ56	T	
VCCIO	VCCIO6	6			VCCIO6	6			
W8	PL43B	6	LDQ42	C	PL57B	6	LDQ56	C	
Y7	PL44A	6	LDQ42	T (LVDS)*	PL58A	6	LDQ56	T (LVDS)*	
Y8	PL44B	6	LDQ42	C (LVDS)*	PL58B	6	LDQ56	C (LVDS)*	
AC2	PL45A	6	LDQ42	T	PL59A	6	LDQ56	T	
GND	GNDIO6	-			GNDIO6	-			
AD3	PL45B	6	LDQ42	C	PL59B	6	LDQ56	C	
AC3	TCK	-			TCK	-			
AA8	TDI	-			TDI	-			
AB4	TMS	-			TMS	-			
AA5	TDO	-			TDO	-			
AB5	VCCJ	-			VCCJ	-			
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
GND	GNDIO5	-			GNDIO5	-			
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
W17	PB65A	4	BDQ69	T	PB56A	4	BDQ60	T	
AA19	PB65B	4	BDQ69	C	PB56B	4	BDQ60	C	
AC15	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T	
Y18	PB68B	4	BDQ69	C	PB57B	4	BDQ60	C	
AB15	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T	
AC16	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AA17	PB60A	4	BDQS60****	T	PB59A	4	BDQ60	T	
AB16	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AA15	PB51A	4	BDQS51****	T	PB60A	4	BDQS60	T	
W16	PB59B	4	BDQ60	C	PB60B	4	BDQ60	C	
Y15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AC17	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AA18	PB61A	4	BDQ60	T	PB62A	4	BDQ60	T	
Y17	PB61B	4	BDQ60	C	PB62B	4	BDQ60	C	
-	-	-			VCCIO4	4			
GNDIO	GNDIO4	-			-	-			
W15	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
AB17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
VCCIO	VCCIO4	4			VCCIO4	4			
V17	PB73A	4	BDQ69	T	PB72A	4	BDQ69	T	
AA20	PB73B	4	BDQ69	C	PB72B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD13	VCC	-			LRC_SQ_VCCR3	13			
AF14	PB47A	4	BDQ51	T	LRC_SQ_HDINP3	13		T	
AE13	NC	-			LRC_SQ_VCCIB3	13			
AE14	PB41A	4	VREF2_4/BDQ42	T	LRC_SQ_HDINN3	13		C	
AD16	VCC	-			LRC_SQ_VCCTX3	13			
AF17	PB51B	4	BDQ51	C	LRC_SQ_HDOUPT3	13		T	
AF16	NC	-			LRC_SQ_VCCOB3	13			
AE17	PB50A	4	BDQ51	T	LRC_SQ_HDOUPTN3	13		C	
AD17	VCC	-			LRC_SQ_VCCTX2	13			
AE18	PB53B	4	BDQ51	C	LRC_SQ_HDOUPTN2	13		C	
AD18	NC	-			LRC_SQ_VCCOB2	13			
AF18	PB53A	4	BDQ51	T	LRC_SQ_HDOUPT2	13		T	
AD14	VCC	-			LRC_SQ_VCCR2	13			
AE15	PB48B	4	BDQ51	C	LRC_SQ_HDINN2	13		C	
AD15	NC	-			LRC_SQ_VCCIB2	13			
AF15	PB47B	4	BDQ51	C	LRC_SQ_HDINP2	13		T	
AD19	VCC	-			LRC_SQ_VCCP	13			
AC19	PB57B	4	BDQ60	C	LRC_SQ_REFCLKP	13		T	
AB19	PB59A	4	BDQ60	T	LRC_SQ_REFCLKN	13		C	
AE19	VCCAUX	-			LRC_SQ_VCCAUX33	13			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T29	PR48B	3	RDQ52	C (LVDS)*	PR60B	3	RDQ64	C (LVDS)*	
T28	PR48A	3	RDQ52	T (LVDS)*	PR60A	3	RDQ64	T (LVDS)*	
R23	PR46B	3	RLM3_SPLLC_FB_A	C	PR58B	3	RLM3_SPLLC_FB_A/RDQ55	C	
GNDIO	GNDIO3	-			GNDIO3	-			
VCCIO	VCCIO3	3			-	-			
R22	PR46A	3	RLM3_SPLLT_FB_A	T	PR58A	3	RLM3_SPLLT_FB_A/RDQ55	T	
P30	PR45B	3	RLM3_SPLLC_IN_A	C (LVDS)*	PR57B	3	RLM3_SPLLC_IN_A/RDQ55	C (LVDS)*	
R29	PR45A	3	RLM3_SPLLT_IN_A	T (LVDS)*	PR57A	3	RLM3_SPLLT_IN_A/RDQ55	T (LVDS)*	
T27	PR44B	3		C	PR56B	3	RDQ55	C	
-	-	-			VCCIO3	3			
T26	PR44A	3		T	PR56A	3	RDQ55	T	
GNDIO	GNDIO3	-			GNDIO3	-			
N30	PR43B	3		C (LVDS)*	PR53B	3	RDQ55	C (LVDS)*	
N29	PR43A	3		T (LVDS)*	PR53A	3	RDQ55	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
R27	PR42B	3	VREF2_3	C	PR52B	3	VREF2_3/RDQ55	C	
R28	PR42A	3	VREF1_3	T	PR52A	3	VREF1_3/RDQ55	T	
P29	PR41B	3	PCLKC3_0	C (LVDS)*	PR51B	3	PCLKC3_0/RDQ55	C (LVDS)*	
P28	PR41A	3	PCLKT3_0	T (LVDS)*	PR51A	3	PCLKT3_0/RDQ55	T (LVDS)*	
M30	PR39B	2	PCLKC2_0/RDQ36	C	PR49B	2	PCLKC2_0/RDQ46	C	
M29	PR39A	2	PCLKT2_0/RDQ36	T	PR49A	2	PCLKT2_0/RDQ46	T	
GNDIO	GNDIO2	-			GNDIO2	-			
P23	PR38B	2	RDQ36	C (LVDS)*	PR48B	2	RDQ46	C (LVDS)*	
P24	PR38A	2	RDQ36	T (LVDS)*	PR48A	2	RDQ46	T (LVDS)*	
R26	PR37B	2	RDQ36	C	PR47B	2	RDQ46	C	
P27	PR37A	2	RDQ36	T	PR47A	2	RDQ46	T	
VCCIO	VCCIO2	2			VCCIO2	2			
P25	PR36B	2	RDQ36	C (LVDS)*	PR46B	2	RDQ46	C (LVDS)*	
P26	PR36A	2	RDQS36	T (LVDS)*	PR46A	2	RDQS46	T (LVDS)*	
K30	PR35B	2	RDQ36	C	PR45B	2	RDQ46	C	
GNDIO	GNDIO2	-			GNDIO2	-			
K29	PR35A	2	RDQ36	T	PR45A	2	RDQ46	T	
N22	PR34B	2	RDQ36	C (LVDS)*	PR44B	2	RDQ46	C (LVDS)*	
P22	PR34A	2	RDQ36	T (LVDS)*	PR44A	2	RDQ46	T (LVDS)*	
J30	PR33B	2	RUM3_SPLLC_FB_A/RDQ36	C	PR43B	2	RUM3_SPLLC_FB_A/RDQ46	C	
VCCIO	VCCIO2	2			VCCIO2	2			
J29	PR33A	2	RUM3_SPLLT_FB_A/RDQ36	T	PR43A	2	RUM3_SPLLT_FB_A/RDQ46	T	
N24	PR32B	2	RUM3_SPLLC_IN_A/RDQ36	C (LVDS)*	PR42B	2	RUM3_SPLLC_IN_A/RDQ46	C (LVDS)*	
N23	PR32A	2	RUM3_SPLLT_IN_A/RDQ36	T (LVDS)*	PR42A	2	RUM3_SPLLT_IN_A/RDQ46	T (LVDS)*	
N25	PR30B	2	RDQ27	C	PR40B	2	RDQ37	C	
N26	PR30A	2	RDQ27	T	PR40A	2	RDQ37	T	
GNDIO	GNDIO2	-			GNDIO2	-			
M27	PR29B	2	RDQ27	C (LVDS)*	PR39B	2	RDQ37	C (LVDS)*	
M28	PR29A	2	RDQ27	T (LVDS)*	PR39A	2	RDQ37	T (LVDS)*	
H30	PR28B	2	RDQ27	C	PR38B	2	RDQ37	C	
G30	PR28A	2	RDQ27	T	PR38A	2	RDQ37	T	
VCCIO	VCCIO2	2			VCCIO2	2			
M25	PR27B	2	RDQ27	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K3	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M7	VCCIO7	7			VCCIO7	7			
N10	VCCIO7	7			VCCIO7	7			
N3	VCCIO7	7			VCCIO7	7			
P10	VCCIO7	7			VCCIO7	7			
R6	VCCIO7	7			VCCIO7	7			
AA25	VCCIO8	8			VCCIO8	8			
AD28	VCCIO8	8			VCCIO8	8			
AA10	VCCAUX	-			VCCAUX	-			
AA11	VCCAUX	-			VCCAUX	-			
AA20	VCCAUX	-			VCCAUX	-			
AA21	VCCAUX	-			VCCAUX	-			
K10	VCCAUX	-			VCCAUX	-			
K11	VCCAUX	-			VCCAUX	-			
K20	VCCAUX	-			VCCAUX	-			
K21	VCCAUX	-			VCCAUX	-			
L10	VCCAUX	-			VCCAUX	-			
L11	VCCAUX	-			VCCAUX	-			
L20	VCCAUX	-			VCCAUX	-			
L21	VCCAUX	-			VCCAUX	-			
Y10	VCCAUX	-			VCCAUX	-			
Y11	VCCAUX	-			VCCAUX	-			
Y20	VCCAUX	-			VCCAUX	-			
Y21	VCCAUX	-			VCCAUX	-			
A1	GND	-			GND	-			
A13	GND	-			GND	-			
A18	GND	-			GND	-			
A24	GND	-			GND	-			
A30	GND	-			GND	-			
A7	GND	-			GND	-			
AA14	GND	-			GND	-			
AA15	GND	-			GND	-			
AA16	GND	-			GND	-			
AA17	GND	-			GND	-			
AA24	GND	-			GND	-			
AA27	GND	-			GND	-			
AA4	GND	-			GND	-			
AB24	GND	-			GND	-			
AB7	GND	-			GND	-			
AD12	GND	-			GND	-			
AD19	GND	-			GND	-			
AD27	GND	-			GND	-			
AE22	GND	-			GND	-			
AE27	GND	-			GND	-			
AE4	GND	-			GND	-			
AE9	GND	-			GND	-			
AF14	GND	-			GND	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF17	GND	-			GND	-			
AF25	GND	-			GND	-			
AF6	GND	-			GND	-			
AJ10	GND	-			GND	-			
AJ21	GND	-			GND	-			
AJ27	GND	-			GND	-			
AJ4	GND	-			GND	-			
AK1	GND	-			GND	-			
AK13	GND	-			GND	-			
AK18	GND	-			GND	-			
AK24	GND	-			GND	-			
AK30	GND	-			GND	-			
AK7	GND	-			GND	-			
B10	GND	-			GND	-			
B21	GND	-			GND	-			
B27	GND	-			GND	-			
B4	GND	-			GND	-			
D25	GND	-			GND	-			
D6	GND	-			GND	-			
E14	GND	-			GND	-			
E17	GND	-			GND	-			
F22	GND	-			GND	-			
F27	GND	-			GND	-			
F4	GND	-			GND	-			
F9	GND	-			GND	-			
G12	GND	-			GND	-			
G19	GND	-			GND	-			
J24	GND	-			GND	-			
J7	GND	-			GND	-			
K14	GND	-			GND	-			
K15	GND	-			GND	-			
K16	GND	-			GND	-			
K17	GND	-			GND	-			
K27	GND	-			GND	-			
K4	GND	-			GND	-			
L14	GND	-			GND	-			
L15	GND	-			GND	-			
L16	GND	-			GND	-			
L17	GND	-			GND	-			
M23	GND	-			GND	-			
M8	GND	-			GND	-			
N14	GND	-			GND	-			
N15	GND	-			GND	-			
N16	GND	-			GND	-			
N17	GND	-			GND	-			
N27	GND	-			GND	-			
N4	GND	-			GND	-			
P11	GND	-			GND	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D2	PL9A	7	VREF2_7	T
D3	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-		
J8	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
H7	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
E3	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
E4	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
G6	PL13A	7	LDQ15	T (LVDS)*
F5	PL13B	7	LDQ15	C (LVDS)*
E2	PL14A	7	LDQ15	T
D1	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-		
G5	PL15A	7	LDQS15	T (LVDS)*
G4	PL15B	7	LDQ15	C (LVDS)*
K7	PL16A	7	LDQ15	T
K8	PL16B	7	LDQ15	C
E1	PL17A	7	LDQ15	T (LVDS)*
F2	PL17B	7	LDQ15	C (LVDS)*
F1	PL18A	7	LDQ15	T
GNDIO	GNDIO7	-		
G3	PL18B	7	LDQ15	C
GNDIO	GNDIO7	-		
H5	PL25A	7	LDQ23	T (LVDS)*
H4	PL25B	7	LDQ23	C (LVDS)*
J5	PL26A	7	LDQ23	T
J4	PL26B	7	LDQ23	C
GNDIO	GNDIO7	-		
G2	PL28A	7	LDQ32	T (LVDS)*
G1	PL28B	7	LDQ32	C (LVDS)*
L9	PL29A	7	LDQ32	T
L7	PL29B	7	LDQ32	C
K6	PL30A	7	LDQ32	T (LVDS)*
K5	PL30B	7	LDQ32	C (LVDS)*
L8	PL31A	7	LDQ32	T
L6	PL31B	7	LDQ32	C
GNDIO	GNDIO7	-		
H3	PL32A	7	LDQS32	T (LVDS)*
H2	PL32B	7	LDQ32	C (LVDS)*
N8	PL33A	7	LDQ32	T
M9	PL33B	7	LDQ32	C
J3	PL34A	7	LDQ32	T (LVDS)*
-	-	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208I	131	1.2V	-5	PQFP	208	IND	20
LFE2-20E-6Q208I	131	1.2V	-6	PQFP	208	IND	20
LFE2-20E-5F256I	193	1.2V	-5	fpBGA	256	IND	20
LFE2-20E-6F256I	193	1.2V	-6	fpBGA	256	IND	20
LFE2-20E-5F484I	331	1.2V	-5	fpBGA	484	IND	20
LFE2-20E-6F484I	331	1.2V	-6	fpBGA	484	IND	20
LFE2-20E-5F672I	402	1.2V	-5	fpBGA	672	IND	20
LFE2-20E-6F672I	402	1.2V	-6	fpBGA	672	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5F484I	331	1.2V	-5	fpBGA	484	IND	35
LFE2-35E-6F484I	331	1.2V	-6	fpBGA	484	IND	35
LFE2-35E-5F672I	450	1.2V	-5	fpBGA	672	IND	35
LFE2-35E-6F672I	450	1.2V	-6	fpBGA	672	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5F484I	339	1.2V	-5	fpBGA	484	IND	50
LFE2-50E-6F484I	339	1.2V	-6	fpBGA	484	IND	50
LFE2-50E-5F672I	500	1.2V	-5	fpBGA	672	IND	50
LFE2-50E-6F672I	500	1.2V	-6	fpBGA	672	IND	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5F672I	500	1.2V	-5	fpBGA	672	IND	70
LFE2-70E-6F672I	500	1.2V	-6	fpBGA	672	IND	70
LFE2-70E-5F900I	583	1.2V	-5	fpBGA	900	IND	70
LFE2-70E-6F900I	583	1.2V	-6	fpBGA	900	IND	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2-35E-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2-35E-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2-35E-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2-35E-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2-35E-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2-50E-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2-50E-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	COM	50
LFE2-50E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2-50E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2-50E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	50

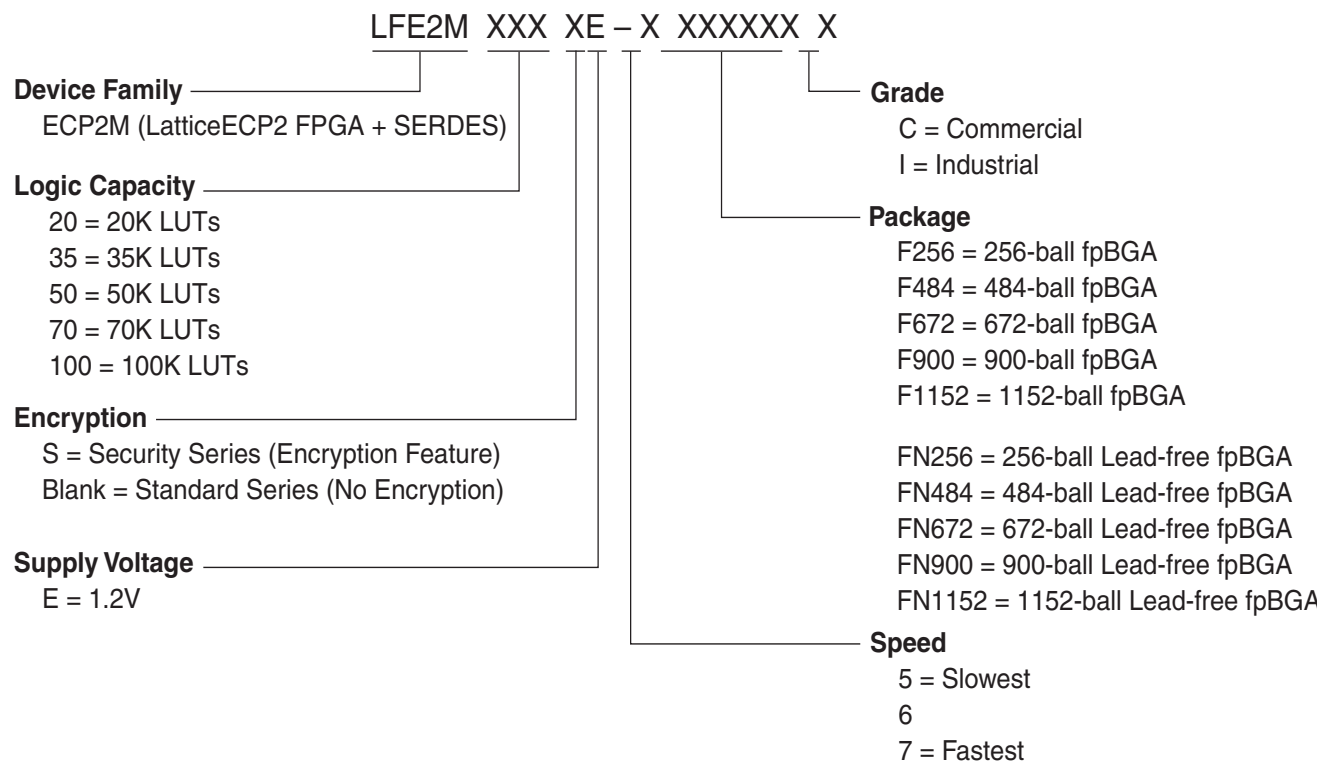
Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	70
LFE2-70E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	70
LFE2-70E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	70
LFE2-70E-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2-70E-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2-70E-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	IND	6
LFE2-6E-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	IND	6
LFE2-6E-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	IND	6
LFE2-6E-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	IND	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	IND	12
LFE2-12E-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	IND	12
LFE2-12E-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	IND	12
LFE2-12E-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	IND	12
LFE2-12E-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	IND	12
LFE2-12E-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	IND	12
LFE2-12E-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	IND	12
LFE2-12E-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	IND	12

LatticeECP2M Part Number Description



Ordering Information

Note: LatticeECP2M devices are dual marked. For example, the commercial speed grade LFE2M50E-7F672C is also marked with industrial grade -6I (LFE2M50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial grade does not have industrial markings. The markings appear as follows:

